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File No.: 1298/0F374

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sailesh CHITTIPEDDI et al.

Serial No.:

09/467,253

Group Art Unit: 2811

Filed: December 20, 1999

Examiner:

Unassigned

For:

WIRE BONDING METHOD FOR COPPER INTERCONNECTS IN SEMICONDUCTOR

**DEVICES** 

## REQUEST FOR CORRECTED FILING RECEIPT

Hon. Commissioner of Patents and Trademarks Washington, D.C. 20231

Attn.: Application Processing Division

**Customer Correction Branch** 

Sir:

TC 2800 MAIL ROOM

A Filing Receipt (copy attached) for the above captioned application has been received by Applicant's attorney. Upon review of this document it was noticed that an error occurred in it. The Patent Office is respectfully requested to make the correction indicated below and to issue a new and correct Filing Receipt.

In the Title, please change "WIRE BONDING METHOD FOR COOPER INTERCONNECTS IN SEMICONDUCTOR DEVICES" TO -- WIRE BONDING METHOD FOR COPPER INTERCONNECTS IN SEMICONDUCTOR DEVICES ---.

Dated: June 14, 2000



Respectfully submitted,

Ya-Chiao Chang

Reg. No. 43,407

Attorney for Applicant(s)

DARBY & DARBY P.C. 805 Third Avenue New York, New York 10022 212-527-7700

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# FILE COPY



Bib Data Sheet



## UNITED STATES DEPARTMENT OF COMMERCE Patent and Trademark Office

Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

SERIAL NUMBI 09/467,253	ER	FILING DATE 12/20/1999 RULE _	CLASS GROU 257 438		2841 2823		ATTORNEY DOCKET NO. 12980F383USO				
SAILESH M	ANSI	PEDDI, ALLENTOWN, NH MERCHANT, ORL	ANDO, FI	-;							
** CONTINUING DATA **********************************											
105 L100 440 (c.d) and Ware 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1						HEETS TOTAWING CLA			INDEPENDENT CLAIMS		
ADDRESS  DARBY & DARBY 805 THIRD AVEN NEW YORK ,NY	IUE	2									
TITLE WIRE BONDING METHOD FOR COPPER INTERCONNECTS IN SEMICONDUCTOR DEVICES											
	FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:					All Fees					
RECEIVED						☐ 1.16 Fees ( Filing )					
						1.17 Fees ( Processing Ext. of time )					
						1.18 Fees ( Issue )					
						Other					
						☐ Credit					

C1 3-1

## FILING RECEIPT



## UNITED STATES DEPARTMENT OF COMMERCE Patent and Trademark Offic

Address: ASSISTANT SECRETARY AND COMMISSIONER OF PATENT AND TRADEMARKS Washington, D.C. 20231

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/467,253	12/20/1999	2811	890	12980F383US	SO 5	20	3

DARBY & DARBY 805 THIRD AVENUE NEW YORK, NY 10022

\*OC000000005094634\*



Date Mailed: 05/04/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

SAILESH CHITTIPEDDI, ALLENTOWN, PA; SAILESH MANSINH MERCHANT, ORLANDO, FL;

**Continuing Data as Claimed by Applicant** 

**Foreign Applications** 

If Required, Foreign Filing License Granted 02/04/2000

10G - 1 2000 TC 2800 MAIL ROOM

Title

COPPER

WIRE BONDING METHOD FOR GOOPER INTERCONNECTS IN SEMICONDUCTOR DEVICES

**Preliminary Class** 

257

Data entry by : ZIMMERMAN, SHAUNA

Team: OIPE

Date: 05/04/2000

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- The docket number allows a maximum of 25 characters.
- If your application was submitted under 37 CFR 1.10, your filing date should be the "date in" found on the Express Mail label. If there is a discrepancy, you should submit a request for a corrected Filing Receipt along with a copy of the Express Mail label showing the "date in."

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